

<b>PATENT ASSIGNMENT COVER SHEET</b>
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EPAS ID: PAT7266786

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
PALAK KADAKIA	12/02/2019
LIJI J. KUNNATH	12/03/2019
AMOL AWATE	11/14/2019
REMUS RUSANU	11/13/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	UIPATH, INC.
<b>Street Address:</b>	90 PARK AVENUE
<b>Internal Address:</b>	20TH FLOOR
<b>City:</b>	NEW YORK
<b>State/Country:</b>	NEW YORK
<b>Postal Code:</b>	10016
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17658260
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(973)907-7035
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	9735302028
<b>Email:</b>	patent@csglaw.com
<b>Correspondent Name:</b>	JEFFREY M. WEINICK
<b>Address Line 1:</b>	CHIESA SHAHINIAN & GIANTOMASI PC
<b>Address Line 2:</b>	ONE BOLAND DRIVE
<b>Address Line 4:</b>	WEST ORANGE, NEW JERSEY 07052
<b>ATTORNEY DOCKET NUMBER:</b>	23464.0196
<b>NAME OF SUBMITTER:</b>	DIKLA BOROCHOV
<b>SIGNATURE:</b>	/Dikla Borochov/
<b>DATE SIGNED:</b>	04/07/2022
<b>Total Attachments: 5</b>	

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**ASSIGNMENT/AGREEMENT**

WHEREAS:

(A) **Palak KADAKIA**, a citizen of the country of Canada, residing in Redmond, Washington, United States;

(B) **Liji J. KUNNATH**, a citizen of the country of India, residing in Bangalore, Karnataka, India;

(C) **Amof AWATE**, citizen of the country of India, residing in Bangalore, Karnataka, India; and

(D) **Remus RUSANU**, citizen of the country of the United States of America, residing in Redmond, Washington, United States,

(hereinafter collectively referred to as ASSIGNOR(S)), have made a discovery and/or invention entitled:

**LONG RUNNING WORKFLOWS FOR ROBOTIC PROCESS AUTOMATION**

described in an application for Letters Patent of the United States, claiming priority to **Indian Patent Application Serial No. 201911041916**, filed **October 16, 2019**,

AND WHEREAS:

**UiPath, Inc.**, a United States Corporation, having its administrative offices located at 90 Park Avenue, 20<sup>th</sup> Floor, New York, NY 10016, United States of America,

and which, together with its successors, assigns, and legal representatives, is hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

Be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign, and transfer to ASSIGNEE the full and exclusive right, title, and interest to the invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for the invention by the application or any continuation, continuation-in-part, divisional, reexamination, reissue and/or any other application claiming priority thereof, including any legal equivalent thereof, in a foreign country for the full term or terms for which the same may be granted.

I/WE, SAID ASSIGNOR(S), hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and any Official of any country or countries foreign to the United States of America whose duty it is to issue Letters Patent on applications as aforesaid, to issue all such Letters Patent for the invention to the ASSIGNEE, as assignee of the entire right, title, and interest in, to and under the same, for the sole use and benefit of the ASSIGNEE in accordance with the terms of this instrument.

I/WE, SAID ASSIGNOR(S), hereby covenant with ASSIGNEE that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned and that I/we have full right to convey the entire right, title, and interest herein sold, assigned, transferred, and set over.

I/WE, SAID ASSIGNOR(S), hereby further covenant and agree that the ASSIGNEE may apply for foreign Letters Patent on the invention and claim the benefits of the International Convention, and that I/we will, at any time, when called upon to do so by the ASSIGNEE, communicate to the ASSIGNEE as the case may be, any facts known to me respecting the invention, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title to the invention, the applications, and the Letters Patent in the ASSIGNEE, and that if reissues or reexaminations of the Letters Patent or disclaimers relating thereto, or divisionals, continuations, or continuations-in-part of the application shall hereafter be desired by the ASSIGNEE, I/we will, at any time, when called upon to do so by the ASSIGNEE, sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers and all divisional, continuation, continuation-in-part, reexamination, and reissue applications so desired, and do all lawful acts requisite for the application for such continuations, continuations-in-part, divisionals, reexaminations, or reissues and the procuring thereof and for the filing of such disclaimers and such applications, and generally do everything possible to aid the ASSIGNEE to obtain and enforce proper patent protection for the invention in all countries, all without further compensation but at the expense of the ASSIGNEE.

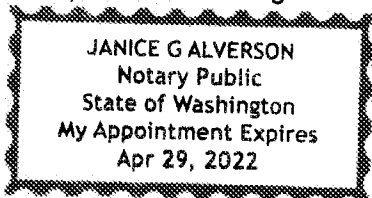
Signature of Inventor(s):

  
\_\_\_\_\_  
Palak KADAKIA

Date: December 2, 2019

United States of America       )  
State of Washington        )  
County of King                )

On this 2<sup>nd</sup> day of December, 2019, before me personally came **Palak KADAKIA**, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.




  
\_\_\_\_\_  
Notary Public

Executed this 03 day of December, 2019


  
\_\_\_\_\_  
Liji J. KUNNATH

Witnessed by:

BHUVANA SEKAR  
\_\_\_\_\_  
Witness Printed Name

  
\_\_\_\_\_  
Signature

VENKATA SUBRAMANIAN  
\_\_\_\_\_  
Witness Printed Name

  
\_\_\_\_\_  
Signature

Executed this 16<sup>th</sup> day of November, 2019

Amol Awate  
Amol AWATE

Witnessed by:

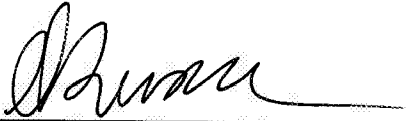
ANUPAM TRIWEDI  
Witness Printed Name

अनुप त्रिद  
Signature

NAWAZ PASHA  
Witness Printed Name

Nawaz  
Signature

Attorney Docket No.: 23464.0004

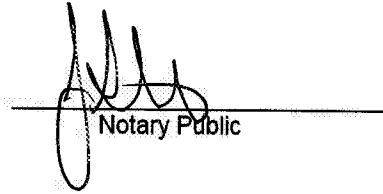
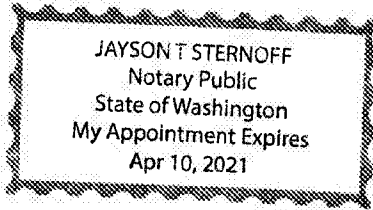


Remus RUSANU

Date: 11/13/19

United States of America )  
State of )  
County of )

On this 13<sup>th</sup> day of November, 2019, before me personally came **Remus RUSANU**, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.

  
Notary Public